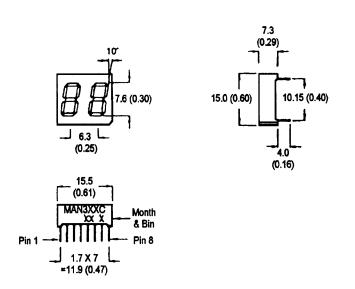


BRIGHT RED MSD314C, MSD315C GREEN MSD344C, MSD345C HIGH EFF. RED MSD394C, MSD395C

PACKAGE DIMENSIONS



FEATURES

Easy to read digits.

2 digit common anode or cathode.

Low power consumption.

Bold segments that are highly visible.

High brightness with high contrast

White segments on a grey face.

Directly compatible with integrated circuits.

Rugged plastic/epoxy construction.

APPLICATIONS

Digital readout displays. Instrument panels.

NOTES: Dimensions are in mm (inch). All pins are 0.5 (0.02) diameter Tolerances are \pm 0.25 (0.1) unless otherwise noted.

MODEL NUMBERS

Part number	<u>Color</u>	Description
MSD314C	Bright Red	2 Digit, Common Anode.
MSD315C	Bright Red	2 Digit, Common Cathode.
MSD344C	Green	2 Digit, Common Anode.
MSD345C	Green	2 Digit, Common Cathode.
MSD394C	High Eff. Red	2 Digit, Common Anode.
MSD395C	High Eff. Red	2 Digit, Common Cathode.

(For other color options, contact your local area Sales Office)



ABSOLUTE MAXIMUM RATING (Ta=25°C unless otherwise specified)

	B.Red	Green	High Eff. R	ed
	MSD	MSD	MSD	
taSheet4U.com	314C	344C	394C	
Part number	315C	345C	395C	Unit
Continuous forward current (I _f)				
Per Segment	15	25	25	mA
Peak forward current per die (I _f) (at f = 10.0 KHz, Duty factor = 1/10)	60	90	90	mA
Power dissipation (P _p)	40*	70*	70*	mW
*Derate Linearly from 25°C Reverse voltage per dice	0.17	0.33	0.33	mW/°C 5V
Operating and Storage temperature ra				to +85°C
Lead soldering time (at 1/16 inch from the	_			

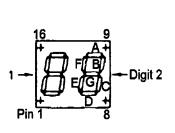
ELECTRO - OPTICAL CHARACTERISTICS (T_A = 25°C unless otherwise specified)

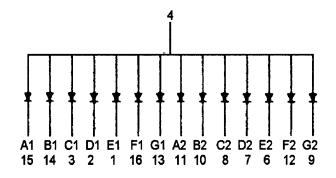
	B. Red MSD 314C	Green MSD 344C	High Eff. Red MSD 394C	Test
<u>Part number</u>	315C	345C	395C	Condition
Luminous intensity (ucd)				
minimum	210	540	800	I, = 20 mA
typical	650	1600	2200	I, = 20 mA
Forward voltage (V,)				
typical	2.1	2.1	2.0	l, = 20 mA
maximum	2.6	2.8	2.8	l, = 20 mA
Peak wavelength (nm)	697	570	635	I, = 20 mA
Spectral line half width (nm)	90	30	45	I, = 20 mA
Reverse breakdown voltage (V _R)	5	5	5	I _R =100 uA



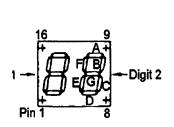
PINOUT

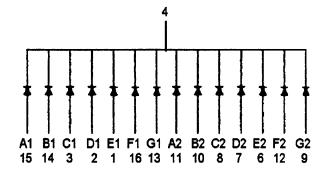
MSD3X4C - Common Anode





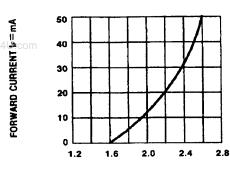
MSD3X5C - Common Cathode



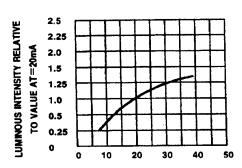




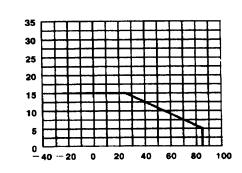
GRAPHICAL DETAIL: Bright Red (T_A = 25°C unless otherwise specified)



FORWARD VOLTAGE (Vr)-VOLTS
Fig.1 FORWARD CURRENT VS. FORWARD VOLTAGE.

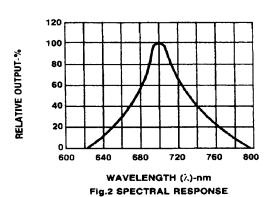


IF-FORWARD CURRENT-MA
Fig.3 RELATIVE LUMINOUS INTENSITY
VS. FORWARD CURRENT



IDCMAX-MAXIMUM DC CURRENT-MA

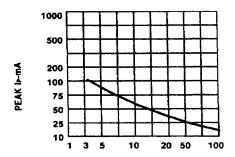
TA AMBIENT TEMPERATURE ©
Fig.4 MAXIMUM ALLOWABLE DC CURRENT PER
SEGMENT VS. A FUNCTION OF AMBIENT
TEMPERATURE.



RELATIVE INTENSITY

10

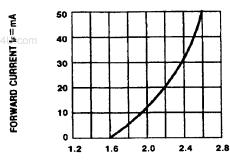
DUTY CYCLE % PER SEGMENT
(AVERAGE I= 10mA)
Fig.5 LUMINOUS INTENSITY VS. DUTY CYCLE



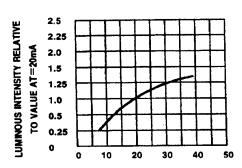
DUTY CYCLE %
Fig. 6 MAX PEAK CURRENT VS. DUTY CYCLE %
(REFRESH RATE 1=1 KHz)



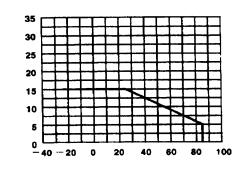
GRAPHICAL DETAIL: Bright Red (T_A = 25°C unless otherwise specified)



FORWARD VOLTAGE (Vr)-VOLTS
Fig.1 FORWARD CURRENT VS. FORWARD VOLTAGE.

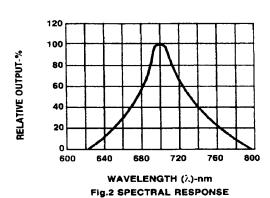


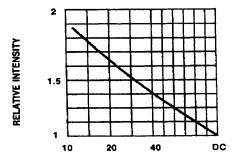
IF-FORWARD CURRENT-MA
Fig.3 RELATIVE LUMINOUS INTENSITY
VS. FORWARD CURRENT



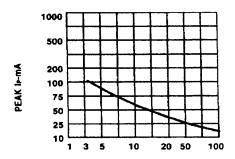
IDCMAX-MAXIMUM DC CURRENT-MA

TA AMBIENT TEMPERATURE ©
Fig.4 MAXIMUM ALLOWABLE DC CURRENT PER
SEGMENT VS. A FUNCTION OF AMBIENT
TEMPERATURE.





DUTY CYCLE % PER SEGMENT
(AVERAGE I==10mA)
Fig.5 LUMINOUS INTENSITY VS. DUTY CYCLE

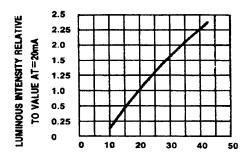


DUTY CYCLE %
Fig. 6 MAX PEAK CURRENT VS. DUTY CYCLE %
(REFRESH RATE 1=1 KHz)

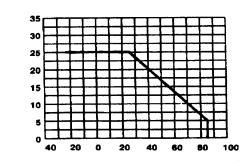


GRAPHICAL DETAIL: High Efficiency Red (T_A = 25°C unless otherwise specified)

FORWARD VOLTAGE (Vr)-VOLTS
Fig.1 FORWARD CURRENT VS. FORWARD VOLTAGE.

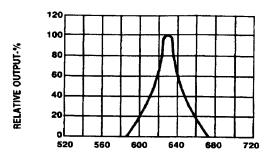


IF-FORWARD CURRENT-MA
Fig.3 RELATIVE LUMINOUS INTENSITY
VS. FORWARD CURRENT

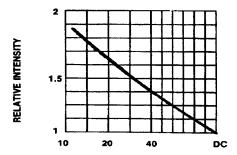


IDCMAX-MAXIMUM DC CURRENT-MA

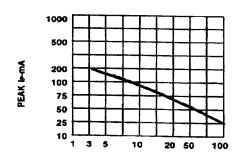
TA AMBIENT TEMPERATURE C Fig.4 MAXIMUM ALLOWABLE DC CURRENT PER SEGMENT VS. A FUNCTION OF AMBIENT TEMPERATURE.



WAVELENGTH (λ)-nm Fig.2 SPECTRAL RESPONSE



DUTY CYCLE % PER SEGMENT
(AVERAGE I=10mA)
Fig.5 LUMINOUS INTENSITY VS. DUTY CYCLE



DUTY CYCLE %
Fig. 6 MAX PEAK CURRENT VS. DUTY CYCLE %
(REFRESH RATE (=1 KHz)



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